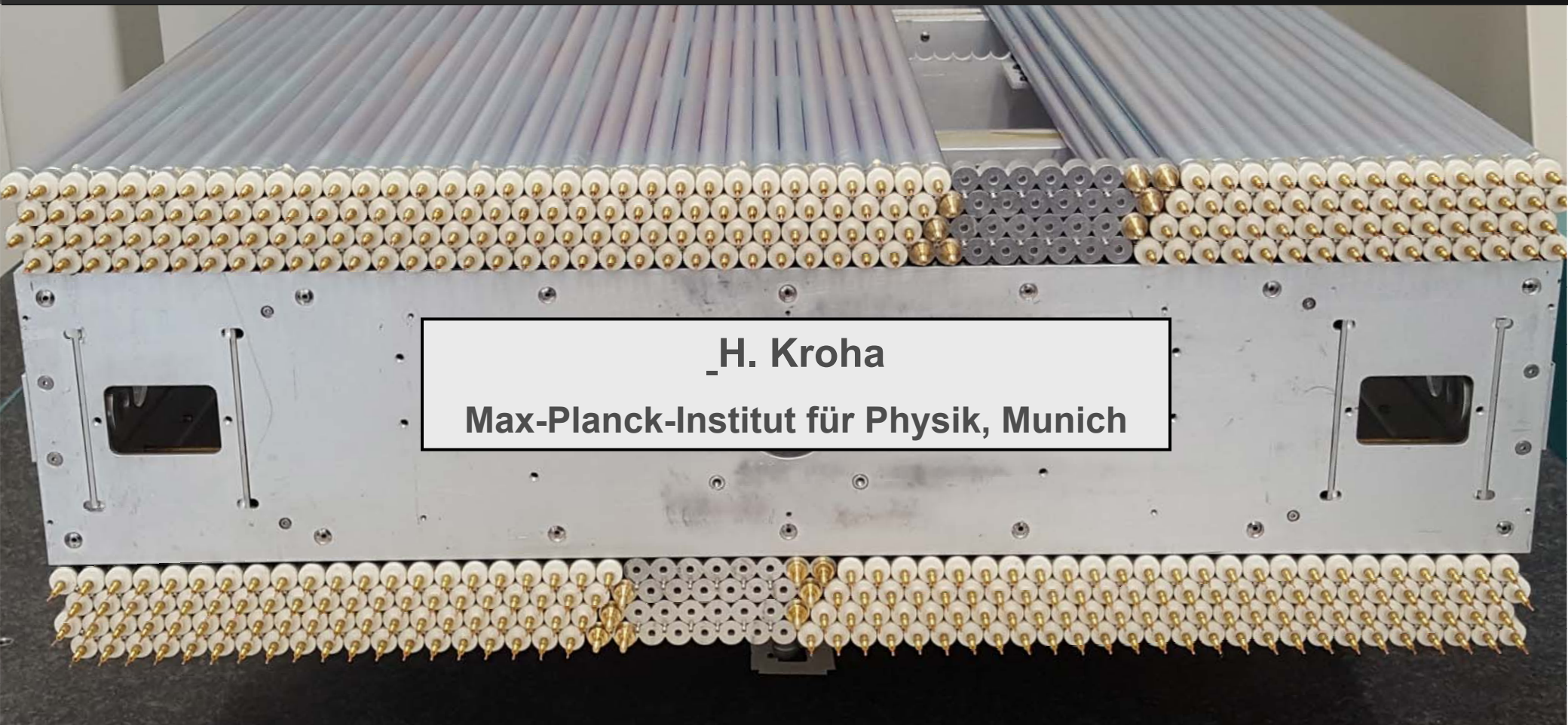
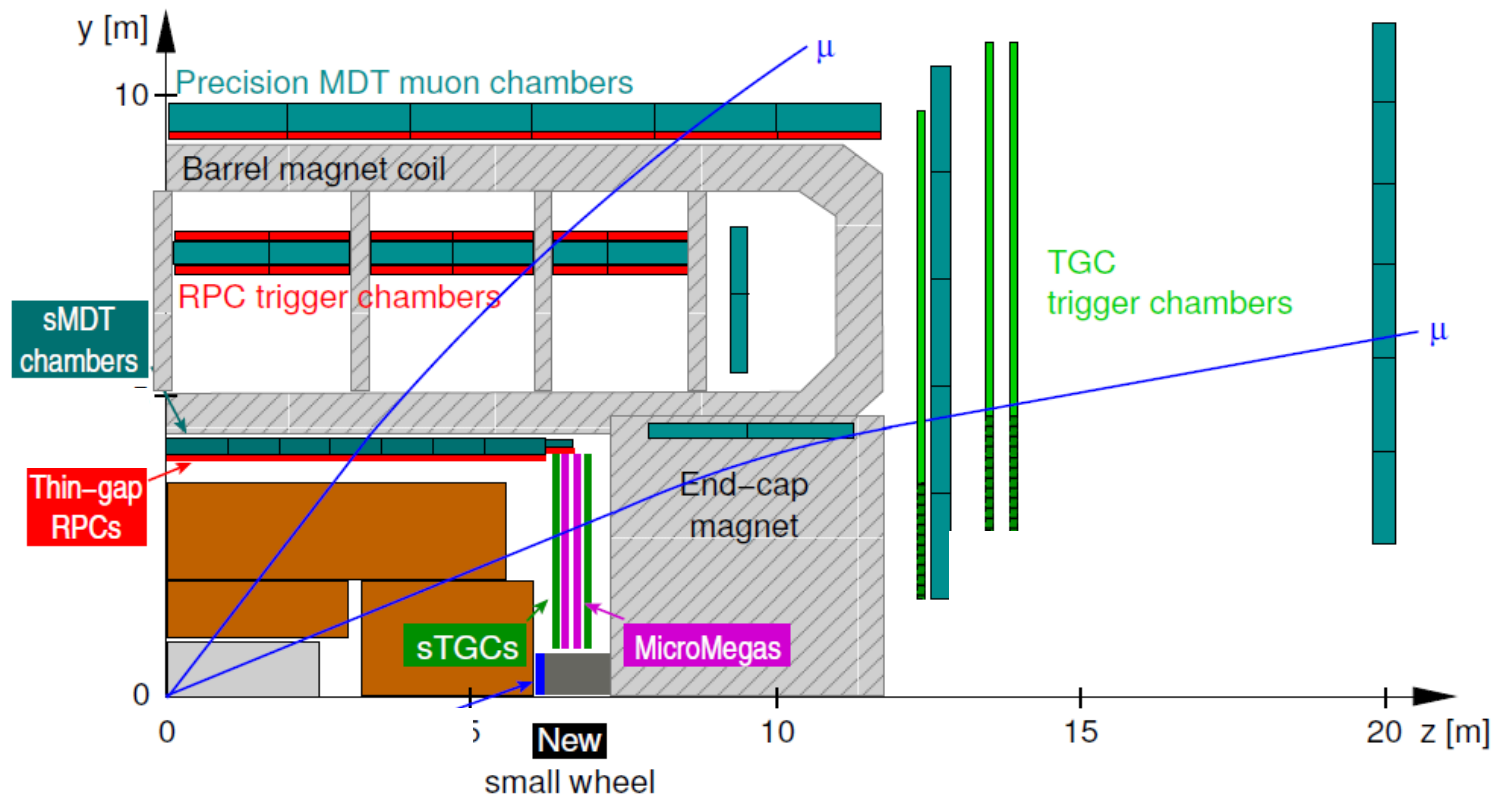


Status of sMDT Chambers for ATLAS



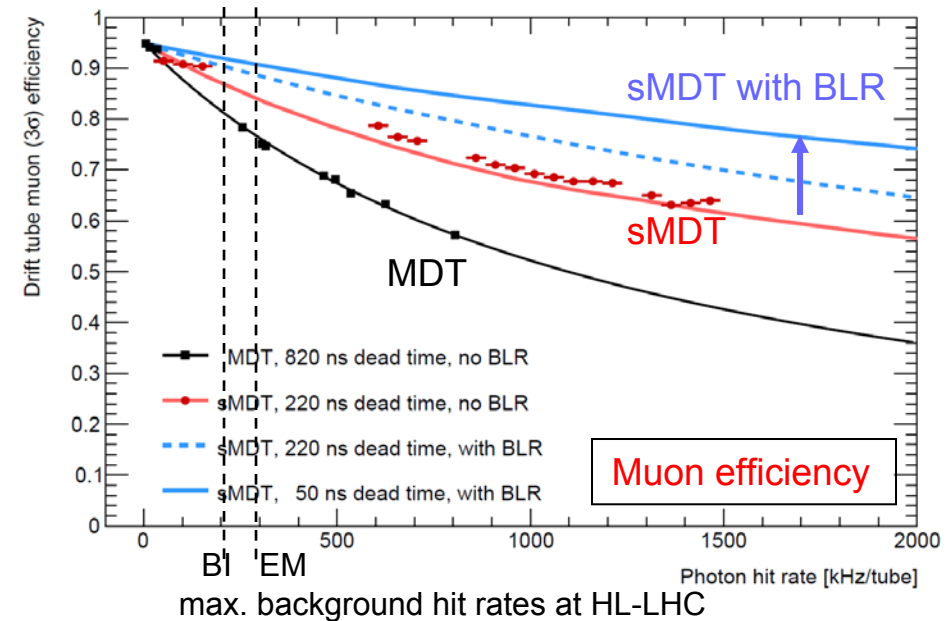
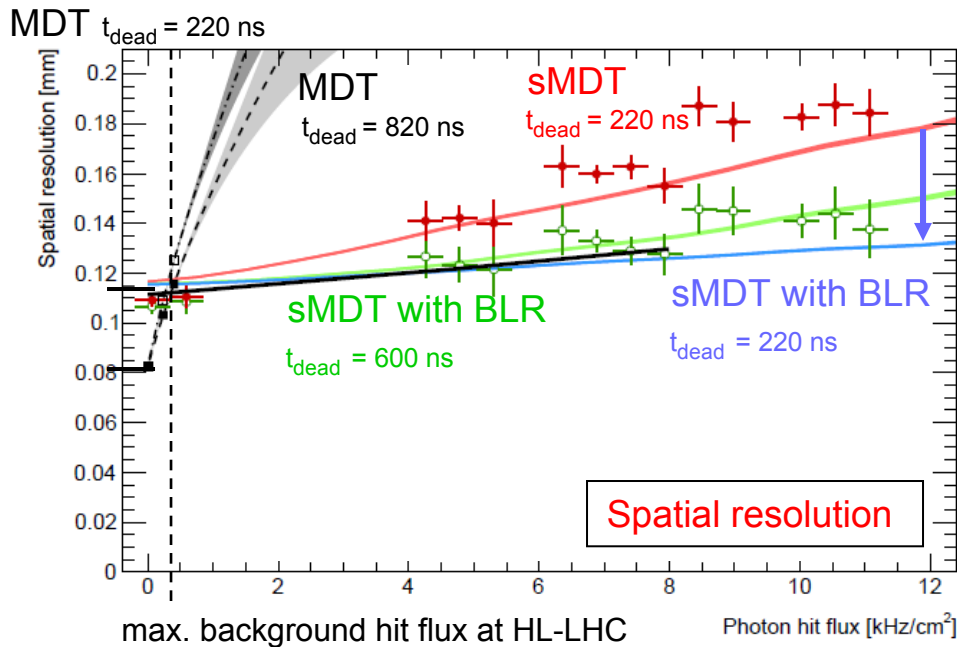
ATLAS Muon Trigger Upgrades for HL-LHC



- New inner endcap layer (small wheel) with high-resolution **sTGC** trigger chambers to reject fake muon triggers and improve momentum resolution at trigger level.
- New **thin-gap RPCs** to close acceptance gaps of the barrel muon trigger.
- Use of the **Monitored Drift-Tube (MDT) precision tracking chambers** in the 1st level muon trigger to improve the momentum resolution to the maximum level.
- New MDT on- and off-chamber electronics for new read-out and trigger architecture.

Rate Capability of sMDT vs MDT Drift Tubes

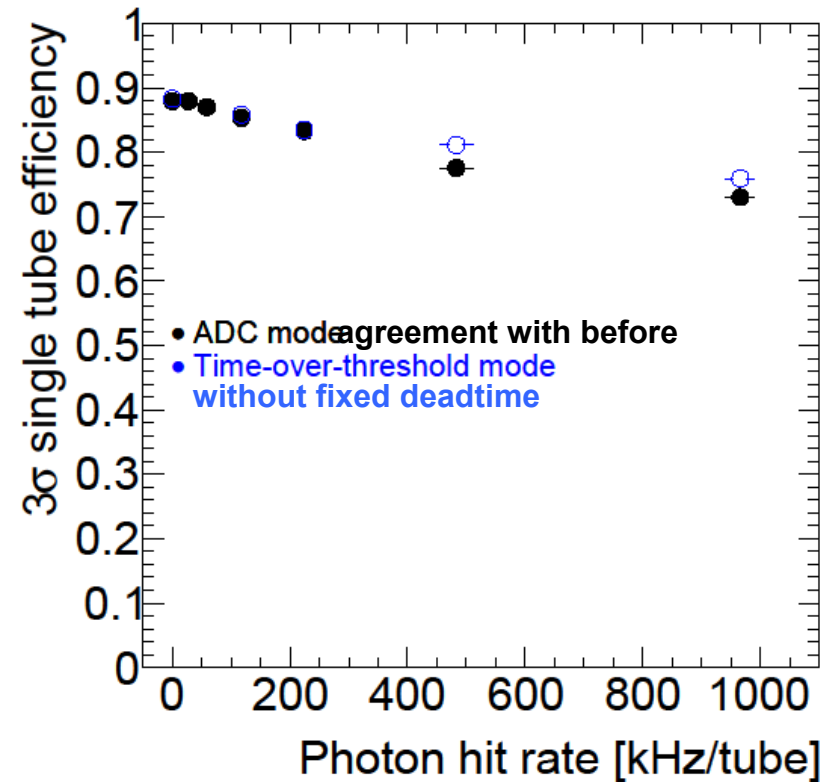
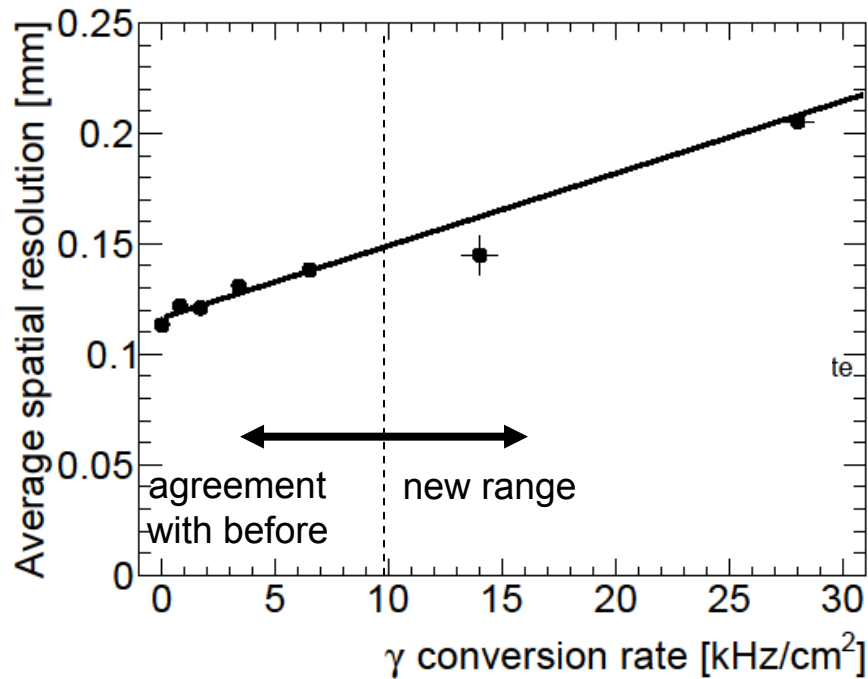
Measurements at the CERN Gamma Irradiation Facility (GIF) with 0.5 TBq ^{137}Cs source and cosmic muons using standard MDT readout electronics (bipolar shaping, 220 ns minimum adjustable deadtime, Wilkinson ADC for time slewing corrections applied here):



Active baseline restoration (BLR) in FE chip desirable for very high background counting rates, e.g. at FCC-hh. Not needed for ATLAS at HL-LHC.

Rate Capability of sMDT Drift Tubes

Update from 2016 measurements in GIF++ with 14 Tbq ^{137}Cs γ source and high-energy muon beam with new stacked boards:



ATLAS Muon Chamber Upgrades

LHC / HL-LHC Plan



2014 (LS1):
2 sMDT + 4 RPC chambers
 to improve acceptance and momentum resolution (by factor 2 – 4 at 1 TeV) in the bottom barrel sector.
Pilot project for phase 1.
In operation since Run 2.

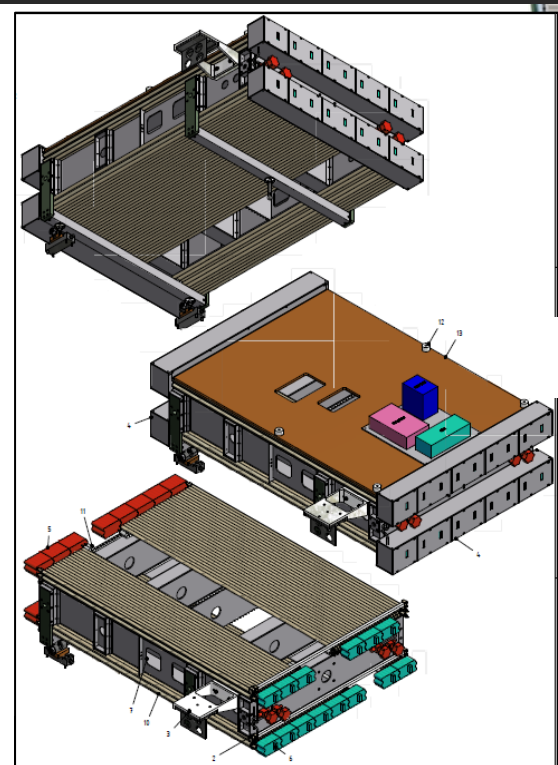
Jan.– Mar. 2017:
12 sMDT chambers
 to improve the momentum resolution (by factor of 2 at 1 TeV) in the regions of the detector feet.
 4500 drift tubes.
 1.1 m x 0.9 m.

2019/20 (LS2):
16 sMDT + 16 RPC chambers
 to improve the trigger selectivity and the rate capability in the barrel inner layer.
Pilot project for phase 2.
 9600 drift tubes.
 1.7 m x 1.4 m.

2024-26 (LS3):
96 sMDT + 276 RPC chambers
 for the barrel inner layer to increase the robustness of the barrel muon trigger system.
 48000 drift tubes.

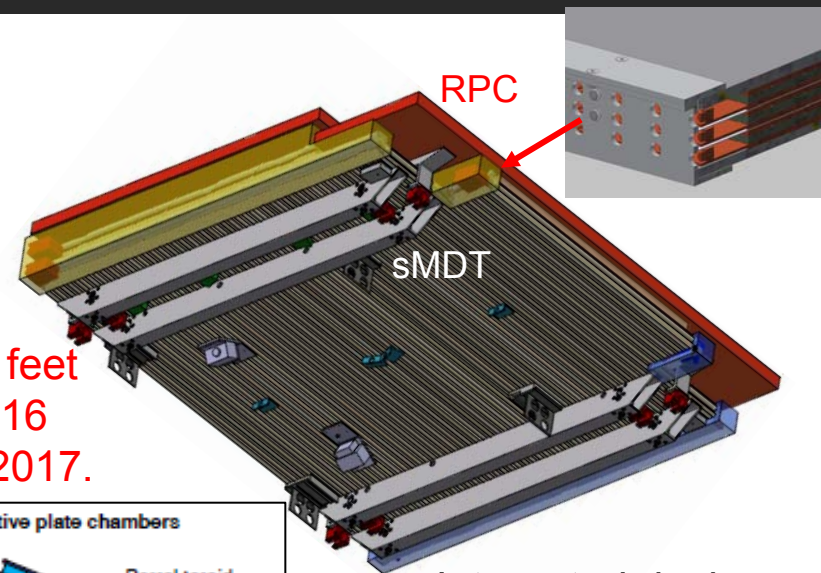
→
 New MDT on-chamber electronics
 with triggerless RO for MDT based L0 μ trigger

sMDT Chambers for ATLAS



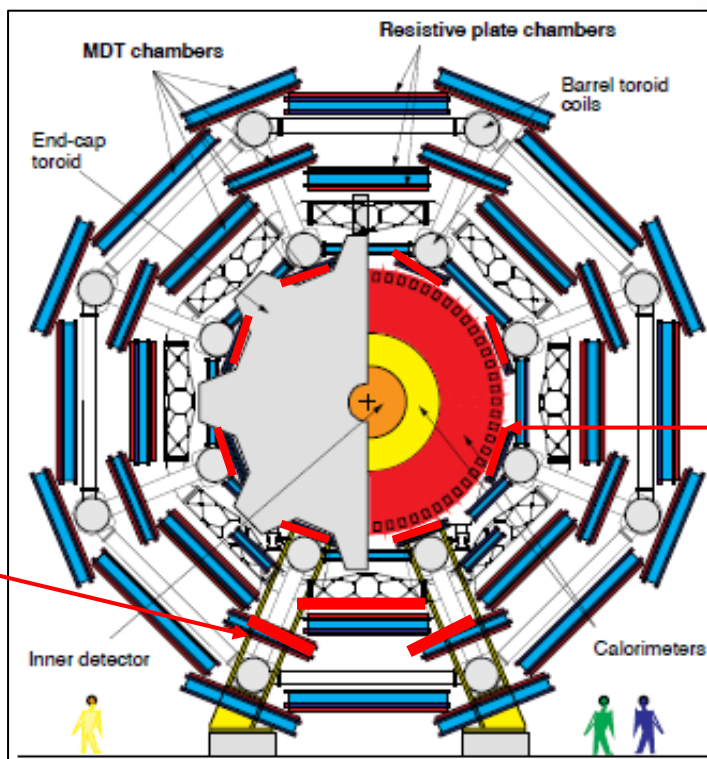
Construction of 12 chambers for the feet regions completed in 09/2015-07/2016 for installation in the first quarter of 2017.

4500 tubes in total.

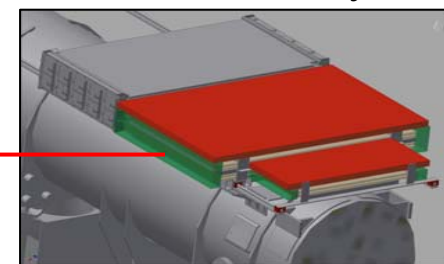


RPC

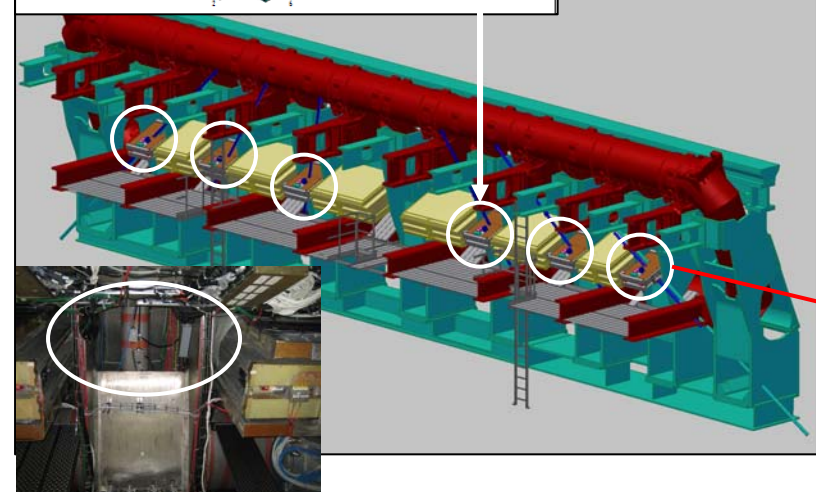
sMDT



Integrated design of sMDTs with triple thin-gap RPCs for barrel inner layer



Design very similar for complete BIS layer replacement



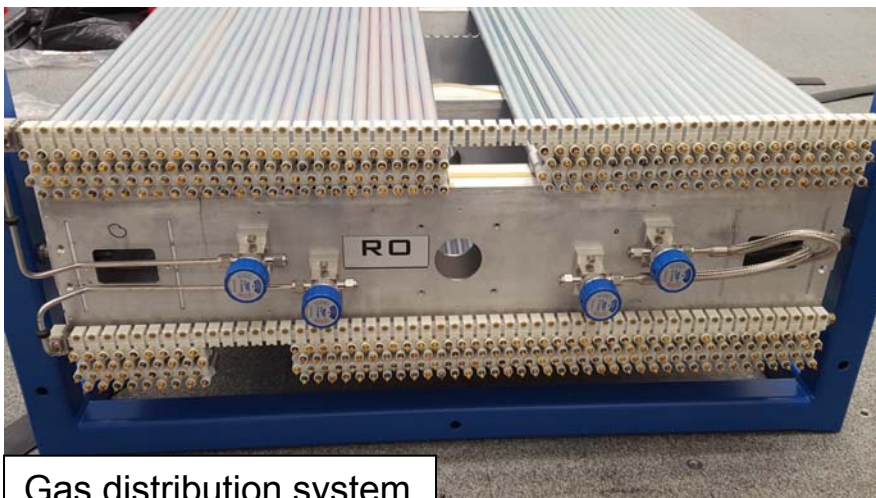
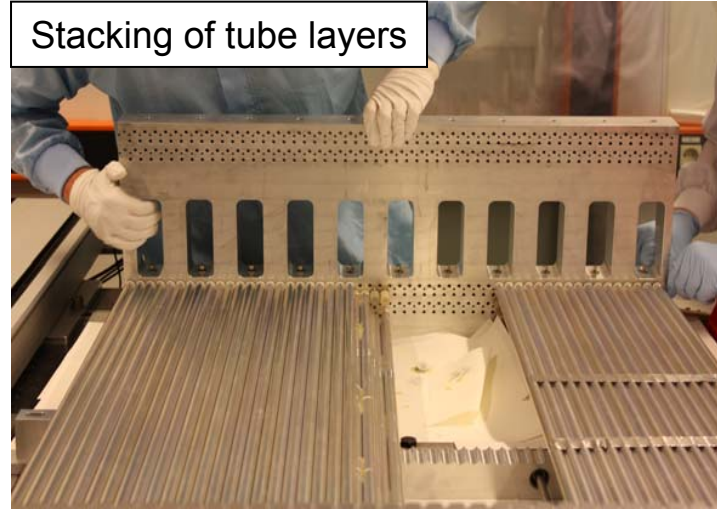
BMG sMDT Chamber Construction

Design for mass production of chambers with large numbers of tube layers:
Assembly within one working day, independent of the number of layers.

Endplug insertion in jigging holes



Stacking of tube layers



Gas distribution system

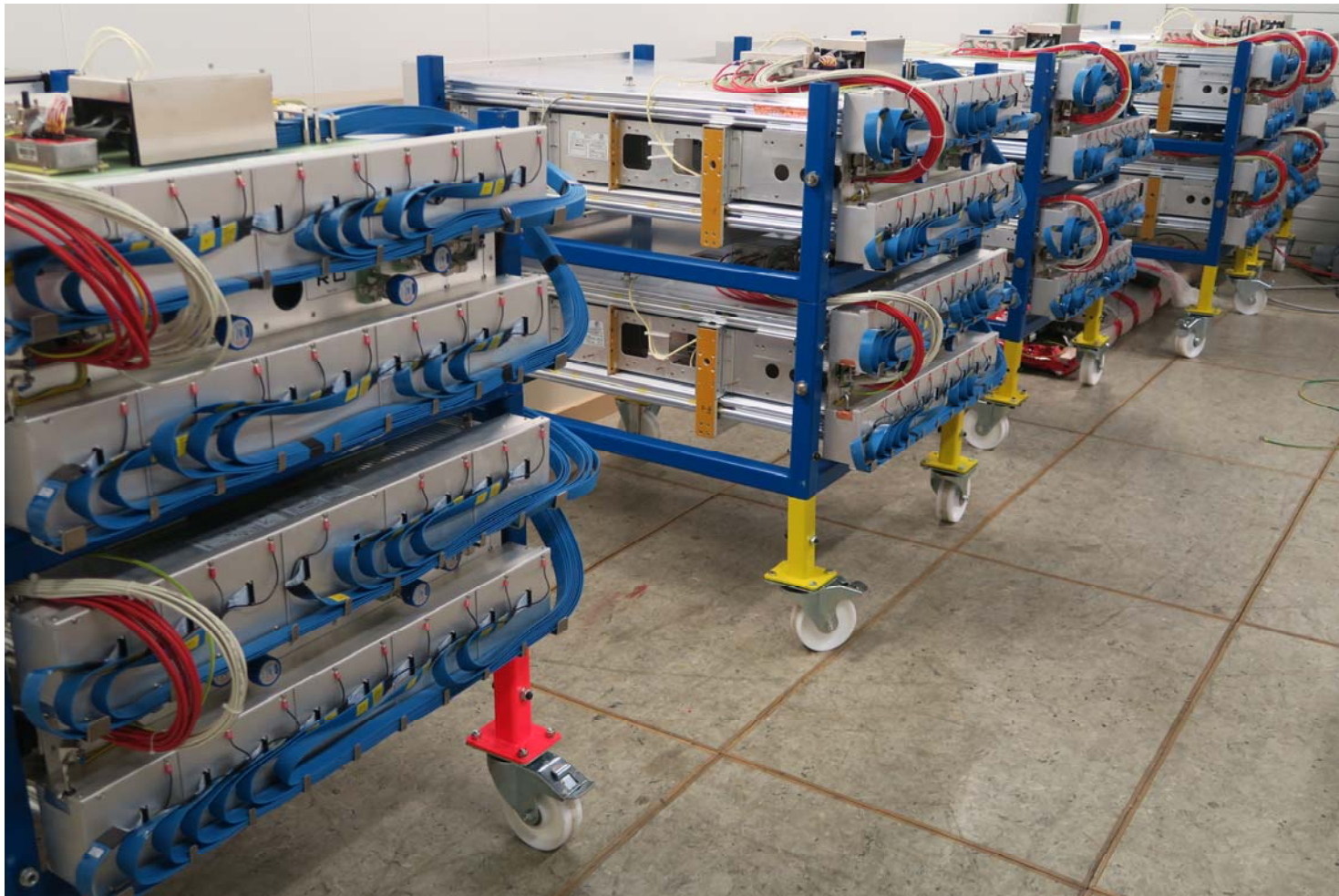


Completed BMG chambers for early 2017 installation

BMG Chamber Commissioning at CERN

Tests of all 12 BMG chambers at CERN completed in December 2016.

Fullfill the specifications and are ready for installation starting on 16 January.

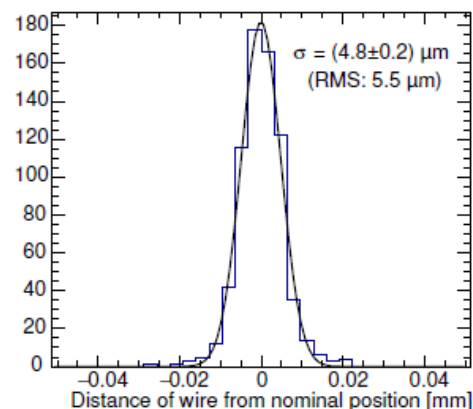
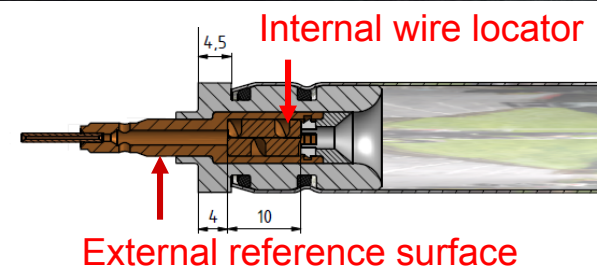


Wire Position Measurement in sMDT Chambers

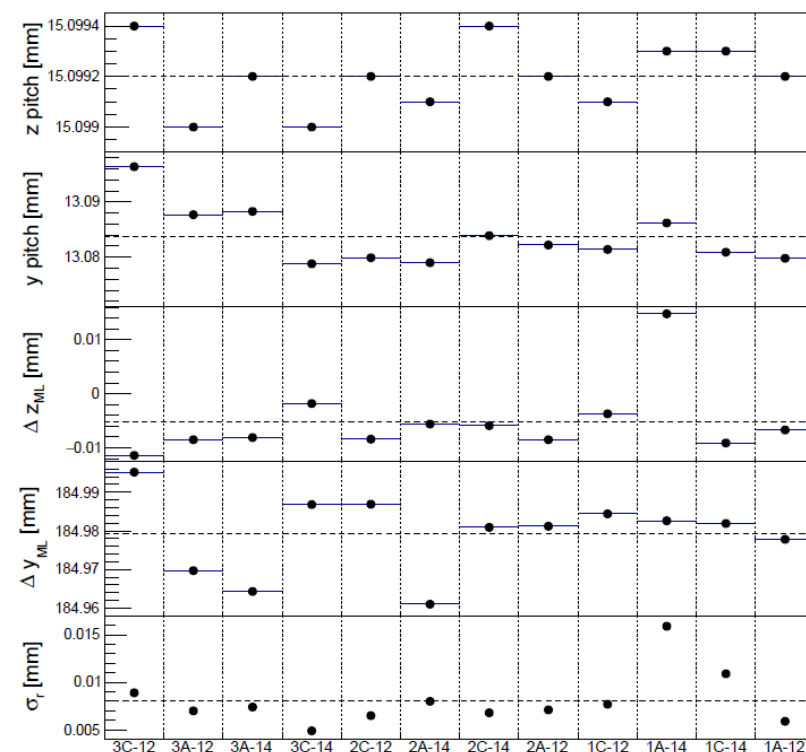


- Measurement of individual sense wire positions and of global deformations (torsion around tube axis) with with 3D coordinate measuring machine.

- **Wire positioning accuracy of better than 5 μm achieved, at the limit of the jiggging precision.**



Chamber Geometry Parameters (RO and HV Common Fit)



Constructed chambers



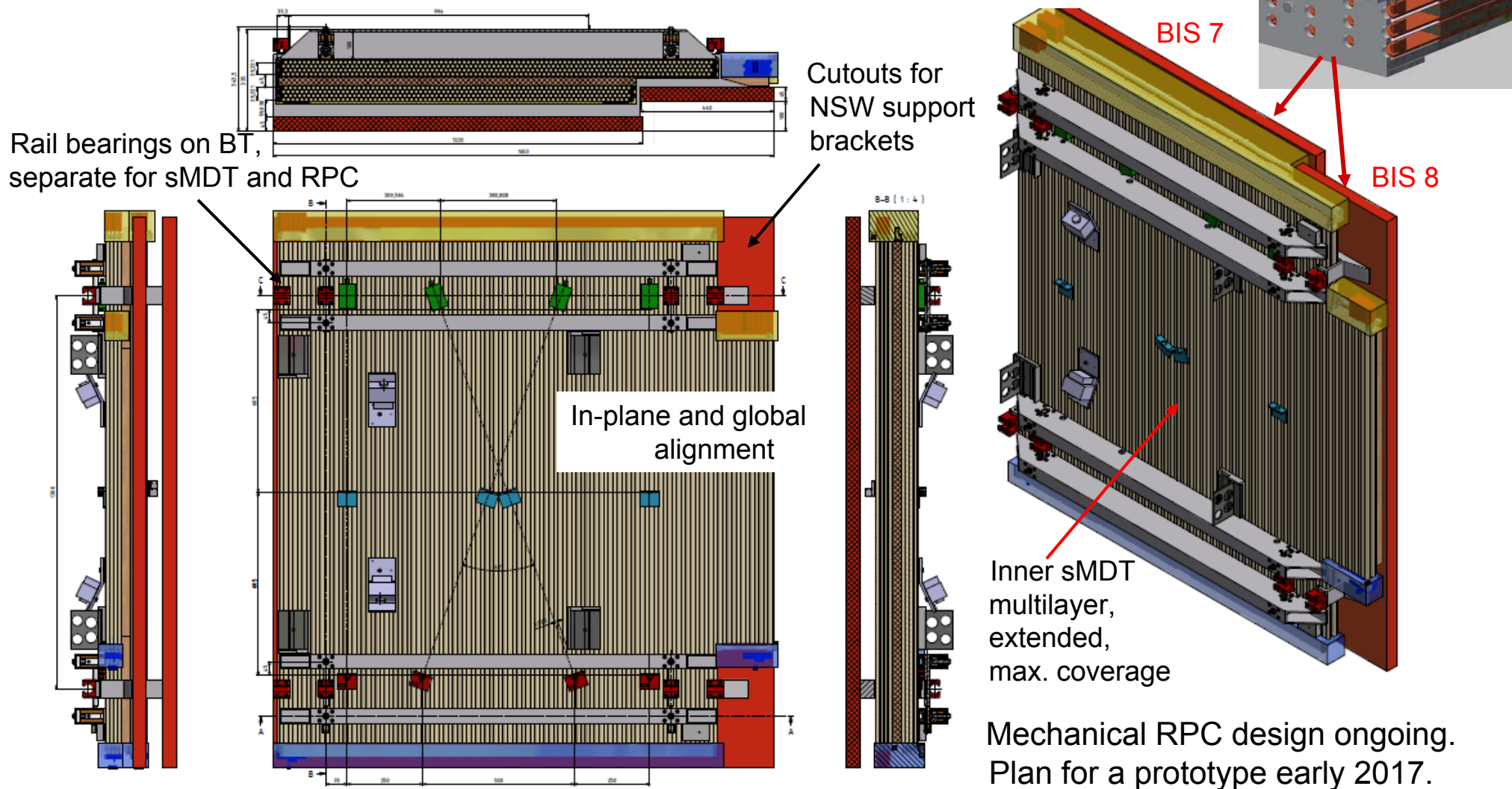
3D position measurement of the optical alignment sensor mounting platforms with respect to the wires.

Essential for absolute optical alignment monitoring with accuracy on the order of the chamber resolution.

BIS 7/8 sMDT + Thin-Gap RPC Chamber Design

Integrated BIS 7/8 sMDT and RPC design with alignment connections to NSW.

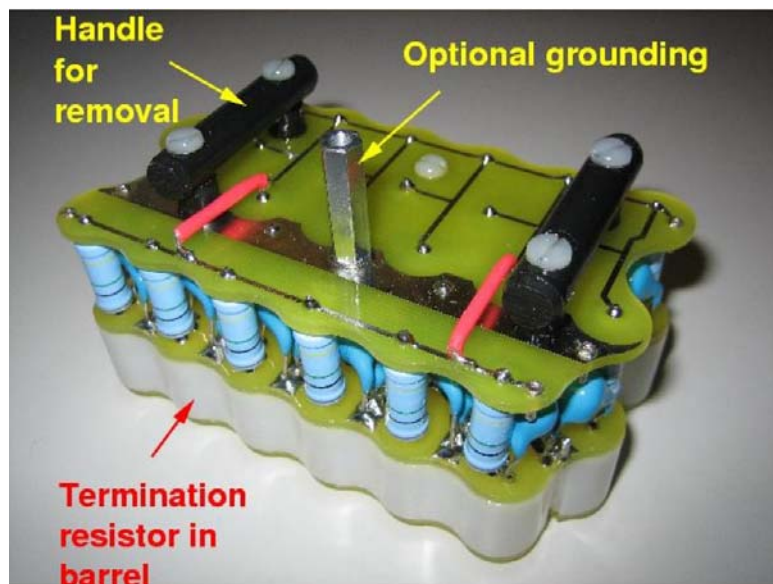
sMDT design close to final. Module 0 March 2017. Model for Phase II BI layer upgrade.



Mechanical RPC design ongoing. Plan for a prototype early 2017.

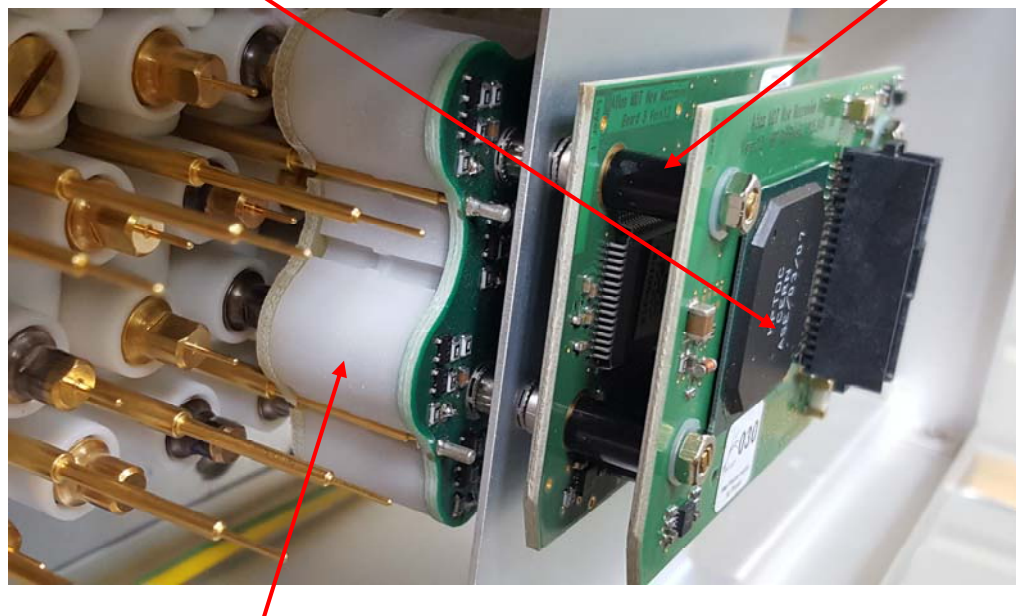
sMDT Readout Electronics

High-voltage distribution boards
(24 channels),



Signal distribution and readout boards (24 channels)

with three 8-channel amplifier-shaper-discriminator (ASD) chips and one TDC chip (CERN HPTDC).



Coupling capacitor in barrel

4 x denser electronics: stacked boards and HV protection.

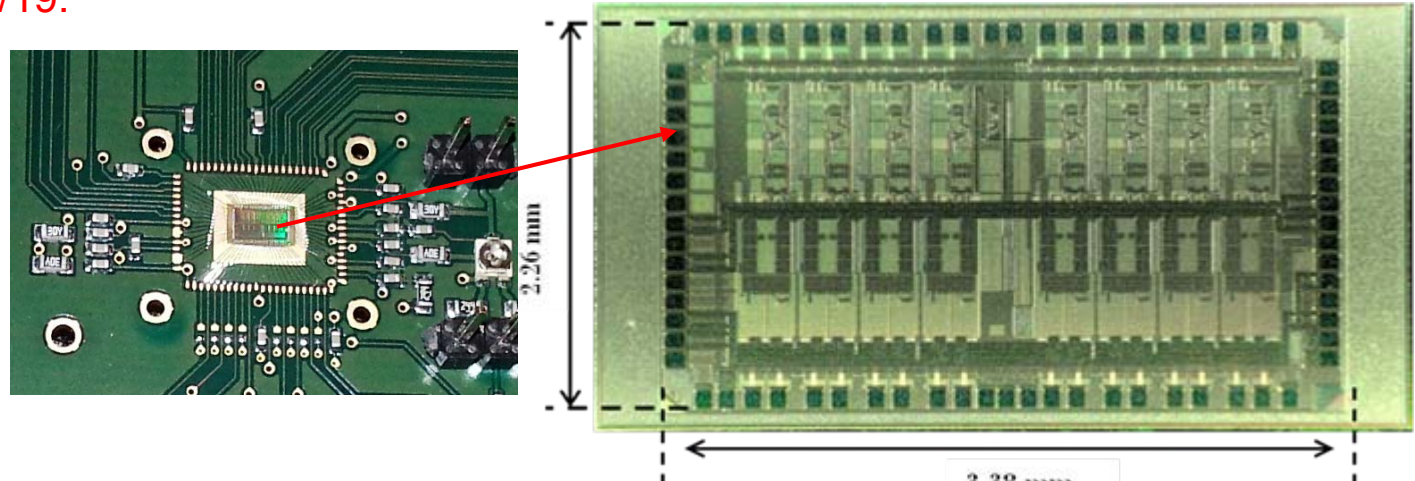
New ASD and TDC chips in 130 nm CMOS technology are under development both for existing ATLAS MDT and new sMDT chambers at HL-LHC.

New TDCs with higher bandwidth and new trigger-less readout for (s)MDT-based Level-0 muon trigger for HL-LHC with offline momentum resolution and thus much sharper trigger threshold.

New (s)MDT Front-end Chips for Phase 2

New ASD and TDC chips in 130 nm CMOS technology are under development both for existing ATLAS MDT and new sMDT chambers at HL-LHC. Plan for procurement in 2018/19.

First test results of new ASD chips from the latest submission received in November 2016 are very promising.



Mezzanine card design also well advanced. Ready for early fabrication and installation in winter shutdowns from 2021/22.



New TDCs with new trigger-less readout, but also compatible with current triggered readout, for (s)MDT-based Level-0 muon trigger for HL-LHC providing full offline momentum resolution and thus much sharper trigger threshold.

Conclusions

- 12 BMG sMDT chambers completed for installation in the winter shutdown 2016/17.
- Design of BIS7/8 sMDT chambers close to completion.
BIS7/8 RPC design in progress.
Module 0 construction in spring 2017. Production of 16 chambers 2017-2018.
- BIS7/8 sMDT and RPC design model for new BI layer for Phase 2.
- New front-end electronics chip and board design for (s)MDT chambers for Phase 2 with additional triggerless readout mode for MDT based L0 muon trigger well advanced. Will be compatible with present triggered readout.
Will be ready for early installation starting from 2021/22.